L Number	Hits	Search Text	DB	Time stamp
1	4	5694481.pn.,6285369.pn.	USPAT;	2004/08/07
•			US-PGPUB;	17:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	23	viewdraw	USPAT;	2004/07/28
			US-PGPUB;	12:55
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0	schematic near3 edit\$3	USPAT;	2004/07/28
			US-PGPUB;	13:01
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	470	schematic near3 edit\$3	USPAT;	2004/07/28
			US-PGPUB;	13:23
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	23	(schematic near3 edit\$3) and (cut same	USPAT;	2004/07/28
		paste)	US-PGPUB;	13:30
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	246	(schematic near3 edit\$3) and ((semi adj	USPAT;	2004/07/28
		conduct\$5) or IC or Chip or semiconductor)	US-PGPUB;	13:33
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	2	(schematic near3 edit\$3) near5 ((semi adj	USPAT;	2004/07/28
		conduct\$5) or IC or Chip or semiconductor)	US-PGPUB;	14:51
			EPO; JPO;	
			DERWENT;	
			!BM_TDB	
-	4471	382/141,144,145,147,151,284,294;29/833;438/1	1	2004/07/28
			US-PGPUB;	14:50
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	1349	382/141,144,145,147,151,284,294;29/833;438/1	1	2004/07/28
		and schematic	US-PGPUB;	14:51
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	
•	3	382/141,144,145,147,151,284,294;29/833;438/1		2004/07/28
		and (schematic near3 edit\$4)	US-PGPUB;	14:51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

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-	793	(382/141,144,145,147,151,284,294;29/833;438/1 and schematic) and ((semi adj conduct\$5) or IC or Chip or semiconductor)	16M2PAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/28 14:55
•	145	(382/141,144,145,147,151,284,294;29/833;438/1 and schematic) and (((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (draw\$6 or plan\$1 or diagram\$1))	_	2004/07/28 15:07
•	48	((382/141,144,145,147,151,284,294;29/833;438/ and schematic) and (((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (draw\$6 or plan\$1 or diagram\$1))) and (edit\$5 or modify\$5 or alter\$5)	1	2004/07/28 14:56
-	29662	(((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:48
-	10	(((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design)) same (schematic near3 edit\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 12:14
•	20	CAE same (((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:38
•	476	((CAE or CAD) and (photomosaic\$1 or mosaic\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:48
•	29697	(((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:48
-	43	(((CAE or CAD) and (photomosaic\$1 or mosaic\$1))) and ((((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 10:48
-	2	(((semi adj conduct\$5) or IC or Chip or semiconductor) near4 (design)) same (schematic near3 edit\$3) and (design near3 analysis)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/29 12:16

•				
•	4	5086477.pn.,5191213.pn.	USPAT; US-PGPUB;	2004/07/29 12:54
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	128	((reverse near3 engineer\$3) near5 (IC or	USPAT;	2004/08/05
		(integrated near3 circuit\$)))	US-PGPUB;	14:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	57	(((reverse near3 engineer\$3) near5 (IC or	USPAT;	2004/08/05
		(integrated near3 circuit\$)))) and schematic	US-PGPUB;	14:44
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	11	((((reverse near3 engineer\$3) near5 (IC or	USPAT;	2004/08/05
		(integrated near3 circuit\$)))) and schematic)	US-PGPUB;	14:50
		and edit\$3	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	2	4766516.pn.	USPAT;	2004/08/05
			US-PGPUB;	14:51
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
•	26	(US-6289116-\$ or US-6236746-\$ or	USPAT;	2004/08/06
		US-5086477-\$ or US-5191213-\$ or	DERWENT	10:47
		US-5185812-\$ or US-6292766-\$ or		
		US-5675499-\$ or US-6553543-\$ or		
		US-5170263-\$ or US-5694481-\$ or		
		US-5629860-\$ or US-5634113-\$ or		
		US-6272668-\$ or US-6077308-\$ or		
		US-6549222-\$ or US-5530372-\$ or		
		US-6738957-\$ or US-5946478-\$ or US-5850348-\$ or US-5553001-\$ or		
		US-4766516-\$ or US-6598210-\$ or		
		US-6591155-\$ or US-6546539-\$).did. or		
		(US-5740071-\$ or US-5901064-\$).did.		
•	2	((US-6289116-\$ or US-6236746-\$ or	USPAT;	2004/08/06
	_	US-5086477-\$ or US-5191213-\$ or	US-PGPUB;	10:48
		US-5185812-\$ or US-6292766-\$ or	EPO; JPO;	10.40
		US-5675499-\$ or US-6553543-\$ or	DERWENT;	<u> </u>
		US-5170263-\$ or US-5694481-\$ or	IBM TDB	
		US-5629860-\$ or US-5634113-\$ or	12	
		US-6272668-\$ or US-6077308-\$ or		
		US-6549222-\$ or US-5530372-\$ or		
		US-6738957-\$ or US-5946478-\$ or		
		US-5850348-\$ or US-5553001-\$ or		
		US-4766516-\$ or US-6598210-\$ or		
		US-6591155-\$ or US-6546539-\$).did. or		
		(US-5740071-\$ or US-5901064-\$).did.) and		
		(cutt\$3 and past\$5)		

•				
-	159	(cutt\$3 and past\$5) same schematic	USPAT;	2004/08/06
			US-PGPUB;	10:50
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	108	(cutt\$3 same past\$5) same schematic	USPAT;	2004/08/06
			US-PGPUB;	10:59
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	52	(extract\$6 same past\$5) same schematic	USPAT;	2004/08/06
			US-PGPUB;	10:59
		·	EPO; JPO;	:
			DERWENT;	
		·	IBM_TDB	
-	1393	(CAD or CAE) same ((cut same paste) or	USPAT;	2004/08/06
		edit\$3)	US-PGPUB;	14:44
		,	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	11	(CAD or CAE) same (cut same paste)	USPAT;	2004/08/06
		(or a or army came (out came pacts)	US-PGPUB;	14:50
			EPO; JPO;	14100
			DERWENT;	
			IBM_TDB	
_	20	(microsoft adj word) same (cut same paste)	USPAT;	2004/08/06
		(iniciosoft duj word) same (cut same paste)	US-PGPUB;	14:53
			EPO; JPO;	14.55
			DERWENT;	
			IBM_TDB	
_	11457	OLE	USPAT;	2004/08/07
	11-37	OLL .	US-PGPUB;	11:01
				11:01
			EPO; JPO; DERWENT;	
			1	
-	3034	Object near3 linking	IBM_TDB USPAT;	2004/09/07
	5554	joot neare mining	US-PGPUB;	2004/08/07 11:02
			EPO; JPO;	11:02
1			DERWENT;	
			IBM_TDB	
_	1113	Object near3 linking near3 embed\$4	USPAT;	2004/08/07
	5	,-ot neare mixing nears embeu74	US-PGPUB;	11:02
			1	11:02
			EPO; JPO;	
			DERWENT;	
_	256	(Object many? linking many? amb 464) and	IBM_TDB	2004/00/07
-	250	(Object near3 linking near3 embed\$4) and schematic	USPAT;	2004/08/07
		SCHEMAUC	US-PGPUB;	11:05
			EPO; JPO;	
1			DERWENT;	
L	L		IBM_TDB	

•				
-	86	(Object near3 linking near3 embed\$4) and schematic and circuit	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/07 11:07
-	47	(Object near3 linking near3 embed\$4) and schematic and (circuit near3 design)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/07 11:07
-	1	(schematic near3 (layout\$ or design\$3)) and (edit\$4 near3 (cut\$3 and past\$4))	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 14:13
-	12	(schematic near3 (layout\$ or design\$3)) and (edit\$4 same (cut\$3 and past\$4))	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 14:17
-	25	(schematic near3 (layout\$ or design\$3 or edit\$)) and (edit\$4 same (cut\$3 and past\$4))	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 14:19
-	13	((schematic near3 (layout\$ or design\$3 or edit\$)) and (edit\$4 same (cut\$3 and past\$4))) not ((schematic near3 (layout\$ or design\$3))	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 14:19
•	9	and (edit\$4 same (cut\$3 and past\$4))) "CAE" and (edit\$4 same (cut\$3 and past\$4))	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 14:32
•	0	6285369.pn. and (serach or find)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 15:38
-	0	6285369.pn. and (search or find)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 15:37
-	2	6285369.pn.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/08/07 15:38
			DERWENT; IBM_TDB	

-	1	6285369.pn. and database	USPAT;	2004/08/07
			US-PGPUB;	15:38
			EPO; JPO;	
			DERWENT;	
			IBM TDB	